DISPLAY Elektronik GmbH

DATA SHEET

LCD MODULE

DEM 20232 SBH-PW-N

Product Specification

Version : 3.1.3

GENERAL SPECIFICATION

MODULE NO.:

DEM 20232 SBH-PW-N

VERSION NO.	CHANGE DESCRIPTION	DATE
0	ORIGINAL VERSION	18.02.2004
1	CHANGED ELECTRICAL CHARACTERISTICS	26.02.2004
2	CHANGED BACKLIGHT AND PCB DRAWING	10.07.2004
3	CHANGED SERIES	01.03.2005
3.1.3	CHANGE IC	25.06.2009

PREPARED BY: HCL DATE: 25.06.2009

APPROVED BY: MH DATE: 25.06.2009

CONTENTS

1. FUNCTIONS & FEATURES	2
2. MECHANICAL SPECIFICATIONS	2
3. BLOCK DIAGRAM	2
4. EXTERNAL DIMENSIONS	3
5. PIN ASSIGNMENT	3
6. PCB DRAWING AND DESCRIPTION	4
7. BACKLIGHT & SWITCH	5
8. DISPLAY DATA RAM (DDRAM)	5
9. MAXIMUM ABSOLUTE LIMIT	6
10. ELECTRICAL CHARACTERISTICS	7
11. CONTROL AND DISPLAY COMMAND	9
12. STANDARD CHARACTER PATTERN	10
13. LCD MODULES HANDLING PRECAUTIONS	11
14. OTHERS	11

1. FUNCTIONS & FEATURES

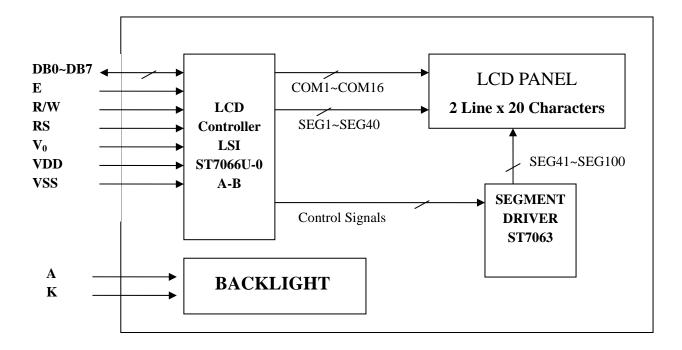
	MODULE	LCD TYPE
	DEM 20232 SBH-PW-N	STN Blue Transmissive Negative Mode
• \	Viewing Direction	: 6 O'clock
• [Driving Scheme	: 1/16 Duty Cycle, 1/5 Bias
• F	ower Supply Voltage	: 5.0 Volt (typ.)
• E	Backlight Color	: LED, Lightguide, White
• 7	V _{LCD} Adjustable for Best Contrast	: 4.5 Volt (typ.)
• [Display contents	: 20 x 2 Characters (5 x 8 dots, Format : 208 Kinds)
• (Operating Temperature	: -20° C to $+70^{\circ}$ C
• S	torage Temperature	: -30° C to $+80^{\circ}$ C
• I	nternal Memory	: CGROM (10,080 bits)
		: CGRAM (64 x 8 bits)
		: DDRAM (80 x 8 bits for Digits)
• (CGROM	: CGROM of the ST7066-0A-B
• I	nterface	: Easy Interface with a 4-bit or 8-bit MPU

2. MECHANICAL SPECIFICATIONS

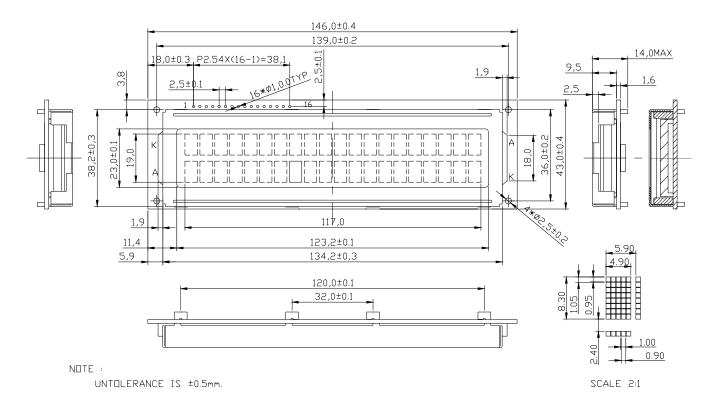
• Module Size : 146.00 x 43.00 x 14.00 mm

Character Pitch : 5.90 x 10.70 mm
 Character Size : 4.90 x 8.30 mm
 Character Font : 5 x 8 dots
 Dot Size : 0.90 x 0.95 mm
 Dot Pitch : 1.00 x 1.05 mm

3. BLOCK DIAGRAM



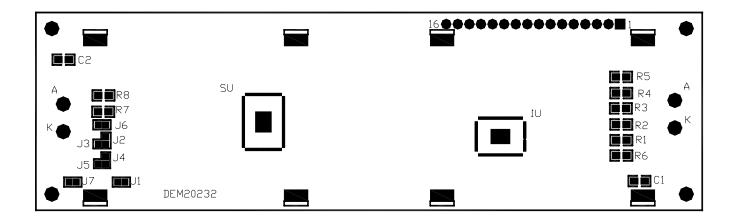
4. EXTERNAL DIMENSIONS



5. PIN ASSIGNMENT

Pin No.	Symbol	Function					
1	Vss	Ground					
2	Vdd	Power supply					
3	V ₀	Power Supply for LCD					
4	RS	Select Display Data ("H") or Instructions ("L")					
5	R/W	Read or Write Select Signal					
6	E	Read/Write Enable Signal					
7	DB0						
8	DB1						
9	DB2						
10	DB3	Display Data Signal					
11	DB4	Display Data Signal					
12	DB5						
13	DB6						
14	DB7						
15	LED – (K)	Please also refer to 6. PCB drawing and description.					
16	LED + (A)	Please also refer to 6. PCB drawing and description.					

6. PCB DRAWING AND DESCRIPTION



Note: The part no. DEM20232 is printed on the PCB.

DESCRIPTION:

6-1-1. The polarity of the pin 15 and the pin 16:

J3,J5	12 14	LED Polarity				
15,15	J2, J4	15 Pin	16 Pin			
Each open	Each closed	Cathode	Anode			
Each closed	Each open	Anode	Cathode			

Note: In application module, J2=J4=closed, J3=J5=open.

6-1-2. The J1 is metal-bezel GND to module GND and J7 is mounting holes GND to module to module GND.

Note: In application module, J1=J7= closed.

6-1-3. The LED resistor should can be bridged when the J6 is open.

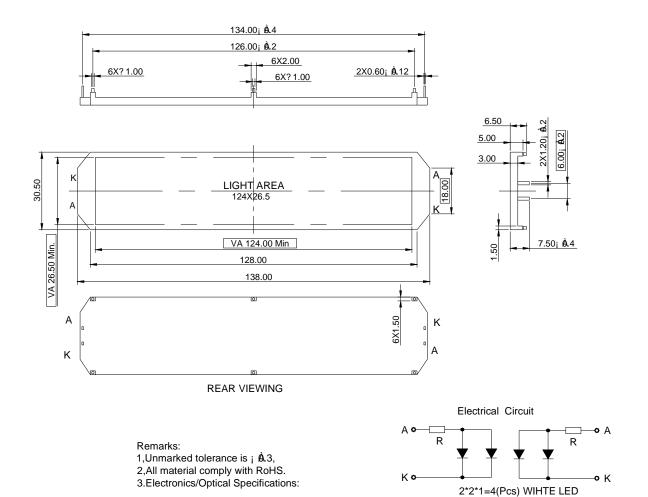
Note: In application module, J6=open

6-1-4. The R7 and the R8 are the LED resistor.

Note: In application module, $R7=24\Omega$, R8=open

7. BACKLIGHT & SWITCH (Ta=-20~+70°C)

	SYMBO	_ MIN.	TYP.	MAX.	UNIT	CONDITIONS
Forward Voltage	Vf		4.2		٧	Vf= 4.2 V
Forward Current	lf		2*30	2*40	mA	
Power Dissipation	Pd			2*0.168	W	Vf= 4.2 V
Reverse Voltage	VR			5	٧	
Reverse Current	IR			2*0.2	mA	
Luminous Intensity	IV	130	200		cd/m ²	Vf= 4.2 V
Luminous Uniformity		70			%	Vf= 4.2 V
Color Chromaticity	Х	0.25		0.30		If=20mA Ta=25°C
Color Chromaticity	Y	0.25		0.32		Each chip



8. DISPLAY DATA RAM (DDRAM)

		1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20-	•	Display	position	1
																							DDRAM	Address	
SECOND	LINE	40	41	42	43	44	45	46	47	48	49	4 A	4 B	4C	4 D	4E	4F	50	51	52	53				

9. MAXIMUM ABSOLUTE LIMIT

Item	Symbol	Standard value	Unit
Power supply voltage(1)	V_{DD}	-0.3~+7.0	V
Power supply voltage(2)	V _{LCD}	V _{DD} -15.0~V _{DD} +0.3	V
Input voltage	V _{IN}	-0.3~V _{DD} +0.3	V
Operating temperature	Topr	-20~+70	°C
Storage temperature	T _{stg}	-30~+80	°C

^{*}Voltage greater than above may damage to the Circuit.

VDD > V1 > V2 > V3 > V4 > V5

10. ELECTRICAL CHARACTERISTICS

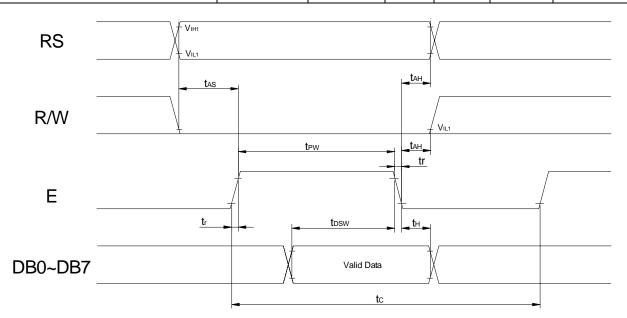
10-1 DC Characteristics $(V_{DD}=4.5V\sim5.5V,Ta=-20\sim+70^{\circ}C)$

Itom	Cymbol	Stan	dard Va	alue	Test	Unit	
Item	Symbol	MIN	TYP	MAX	Condition	Oilit	
Operating Voltage	$V_{ m DD}$	4.5	5	5.5		V	
Supply Current	I_{DD}		0.35	0.6	V _{DD} =5V,fosc=270kHz	mA	
LCD Driving Voltage	VLCD	3.0	4.5	13.0	V _{DD} -V ₅ (1/5,1/4 Bias)	V	

10-2 AC Characteristics (V_{DD} =4.5V~5.5V, Ta=-20~+70°C)

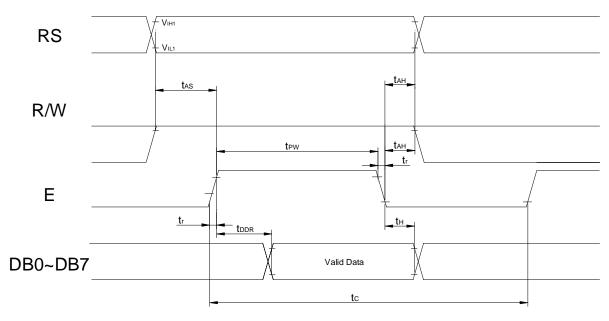
10-2-1 Write mode (writing data from MPU to module)

Characteristic	Symbol	Min	Туре	Max	Unit	Test PIN
E Cycle Time	t _C	1200			ns	E
E Rise Time	t _R			25	ns	Е
E Fall Time	t _F			25	ns	Е
E Pulse width (High,Low)	t _W	140			ns	Е
R/W and RS Set-up Time	t _{SU1}	0			ns	R/W,RS
R/W and RS Hold Time	t _{H1}	10			ns	R/W,RS
Data Set-up Time	t _{SU2}	40			ns	DB0~DB7
Data Hold Time	t _{H2}	10			ns	DB0~DB7



10-2-2 Read mode (reading data from MPU to module)

Characteristic	Symbol	Min	Туре	Max	Unit	Test PIN
E Cycle Time	t _C	1200			ns	E
E Rise Time	t _R			25	ns	E
E Fall Time	t _F			25	ns	E
E Pulse width (High, Low)	t _W	140			ns	Е
R/W and RS Set-up Time	t _{SU}	0			ns	R/W,RS
R/W and RS Hold Time	t _H	10			ns	R/W,RS
Data Output Delay Time	t _D			100	ns	DB0~DB7
Data Hold Time	t _{DH2}	10			ns	DB0~DB7



11. CONTROL AND DISPLAY COMMAND

Command	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Execution time (fosc=270KHz)	Remark
Clear Display	0	0	0	0	0	0	0	0	0	1	1.52ms	Write"20H" to DDRAM. And set DDRAM address to "00H" from AC
Return home	0	0	0	0	0	0	0	0	1	X	1.52ms	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.
Entry mode Set	0	0	0	0	0	0	0	1	I/D	S	37us	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.
Display on/off control	0	0	0	0	0	0	1	D	С	В	37us	D=1: entire display on C=1: cursor on B=1: cursor position on
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	X	X	37us	Set cursor moving and display shift control bit, and the direction, without changing DDRAM data.
function Set	0	0	0	0	1	DL	N	F	Х	Х	37us	DL: interface data is 8/4 bits N: number of line is 2/1 F: font size is 5x11/5x8
Set CGRAM address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	37us	Set CGRAM address in address counter
Set DDRAM address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	37us	Set DDRAM address in address counter
Read busy flag& address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Ous	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.
Write data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	37us	Write data into internal RAM (DDRAM/CGRAM)
Read data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	37us	Read data from internal RAM (DDRAM / CGRAM)

Note:

Be sure the ST7066U is not in the busy state (BF=00 before sending an instruction from the MPU to the ST7066U. If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself. Refer to instruction table for the list of each instruction execution time.

12. STANDARD CHARACTER PATTERN (ST7066U-0A-B)

Upper(4bit)	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	10010	1011	1100	1101	1110	1111
0 0 0 0 0	CGRAM															
0001	(2)															
0010	(3)															
0011	(4)															
0100	(5)															
0101	(6)															
0110	(7)															
0111	(8)															
1000	(1)															
1001	(2)															
1010	(3)															
1011	(4)															
1100	(5)															
1101	(6)															
1110	(7)															
1111	(8)															

13. LCD MODULES HANDLING PRECAUTIONS

- Please remove the protection foil of polarizer before using.
- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance comes into contact with your skin or clothes promptly wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - -Be sure to ground the body when handling the LCD module.
 - -Tools required for assembly, such as soldering irons, must be properly grounded.
 - -To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

Storage precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below 0° C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

14. OTHERS

- Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD modules have been operating for a long time showing the same display, patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:
 - Exposed area of the printed circuit board
 - Terminal electrode sections